

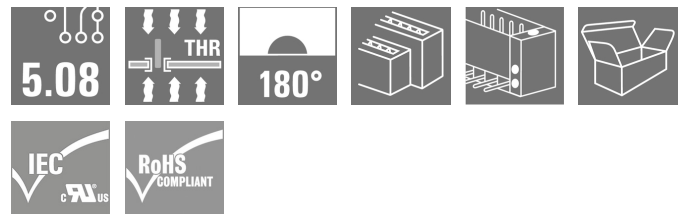
SLDV-THR 5.08/32/180F 4.5SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

High-temperature resistant, double level, laterally offset, male connector with flange or solder flange. 1.5 mm solder pin is suitable for reflow soldering. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded.

General ordering data

Version	PCB plug-in connector, male header, Flange, THT/THR solder connection, 5.08 mm, Number of poles: 32, 180°, Solder pin length (l): 4.5 mm, black, Box
Order No.	1506050000
Type	SLDV-THR 5.08/32/180F 4.5SN BK BX
GTIN (EAN)	4050118314564
Qty.	12 pc(s).
Product data	IEC: 400 V / 15 A UL: 300 V / 10 A
Packaging	Box

Creation date July 2, 2024 11:09:07 AM CEST

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Technical data

Dimensions and weights

Depth	23.67 mm	Depth (inches)	0.932 inch
Height	30.66 mm	Height (inches)	1.207 inch
Height of lowest version	26.16 mm	Width	91.44 mm
Width (inches)	3.6 inch	Net weight	23.438 g

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.08		
Type of connection	Board connection		
Mounting onto the PCB	THT/THR solder connection		
Pitch in mm (P)	5.08 mm		
Pitch in inches (P)	0.2 "		
Outgoing elbow	180°		
Number of poles	32		
Number of solder pins per pole	1		
Solder pin length (l)	4.5 mm		
Solder pin length tolerance	0 / -0.3 mm		
Solder pin dimensions	d = 1.2 mm, Octagonal		
Solder eyelet hole diameter tolerance (D)+	0,1 mm		
L1 in mm	76.2 mm		
L1 in inches	3 "		
Pin series quantity	2		
Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged		
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged		
Protection degree	IP20		
Volume resistance	≤5 mΩ		
Can be coded	Yes		
Plugging force/pole, max.	10 N		
Pulling force/pole, max.	7.5 N		
Tightening torque	Torque type	Mounting screw, PCB	
	Usage information	Tightening torque	min. 0.15 Nm
			max. 0.2 Nm
		Recommended screw	Part number PTSC KA 2.2X4.5 WN1412

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIla
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt	Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, max.	100 °C	Temperature range, installation, max.	100 °C

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Technical data


Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	15 A
Rated current, max. number of poles (Tu=20°C)	10.5 A	Rated current, min. number of poles (Tu=40°C)	13 A
Rated current, max. number of poles (Tu=40°C)	9 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Short-time withstand current resistance	1 x 1s with 120 A

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	177 mm
VPE width	98 mm	VPE height	53 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ETIM 9.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01
ECLASS 12.0	27-46-02-01	ECLASS 13.0	27-46-02-01

Environmental Product Compliance

REACH SVHC	/
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Technical data**Important note**

IPC conformity

Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Notes

- Rated current related to rated cross-section & min. No. of poles.
- Spacing between rows: see hole layout
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load
- Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



ROHS

Conform

UL File Number Search

UL Website

Certificate No. (UR)

E60693

Downloads

Engineering Data

[CAD data – STEP](#)

Product Change Notification

[Anpassung Verpackung SLDV-THR 5.08](#)
[Change of packaging SLDV-THR 5.08](#)

Catalogues

[Catalogues in PDF-format](#)

Brochures

[FL DRIVES EN](#)
[FL DRIVES DE](#)

White paper surface mount technology

[Download Whitepaper](#)

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Drawings

Product image



Dimensional drawing



Product benefits



Safe power transmission
Proven properties

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.